





SPECIFICATION FOR 1.8V CML SMT TCXO MtronPTI P/N M6302S040

Electrical Specifications:

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions	
Frequency of Operation	Fo		125.000000		MHz		
Frequency Tolerance		-1.0		+1.0	ppm	@ +25°C	
Frequency Stability							
vs. Temperature	Δ F/F			4.6	ppm	(Max-Min)/2	
vs. Aging		-3		+3	ppm	1 st year	
		-1		+1	ppm	Per year thereafter.	
			RF Outpu	t			
Output Type			CML				
Output Load		100 Ω Differential			V		
Differential Output Voltage		300	425	500	mV	CML Load	
Symmetry (duty cycle)	T _{DC}	45		55	%	50% (Voн - VoL)	
Rise/Fall Time	T _R /T _F			0.35	nS	From 20% to 80% Vcc	
	S	upply Vo	Itage & Powe	r Consum	ption		
Operating Voltage	Vcc	1.71	1.80	1.89	V		
Operating Current	Icc			125	mA		

Environmental Conditions:

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Operating Temperature	TA	-55		+125	°C	
Storage Temperature	Ts	-55		+125	°C	
Shock	Per MIL-STD-202, Method 213, Condition C (100 g's, 6 ms duration, ½ sinewave)				duration, ½ sinewave)	
Vibration	Per MIL-STD-202, Method 201 & 204 (10 g's from 10-2000 Hz)				Hz)	
Thermal Shock	Per MIL-STD-883, Method 1011, Condition A					
Thermal Cycle	Per MIL-STD-883, Method 1010, Condition B					
Hermeticity	Per MIL-STD-202, Method 112 (1 x 10 ⁻⁸ atm cc/s of helium)					
Moisture Sensitivity Level	MCL 4					
(MSL)	MSL 1					
Solderability	Per EIAJ-STD-002					
Max. Soldering Conditions	See Figure 1.					
Package Type	6-pad 5.0 X 7.0 X 1.9 mm leadless ceramic. RoHS compliant.					

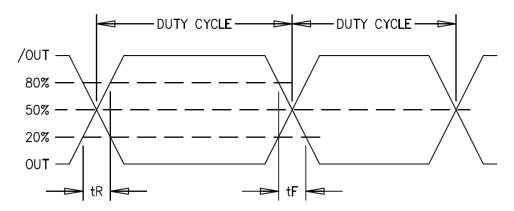




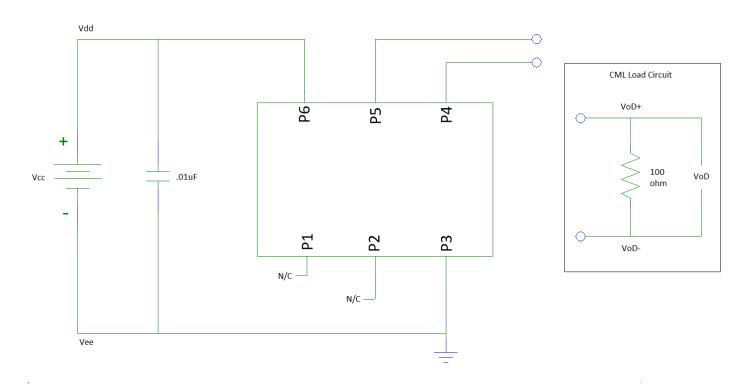


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Output Waveform:



Typical Test Circuit & Load Circuit Diagrams:



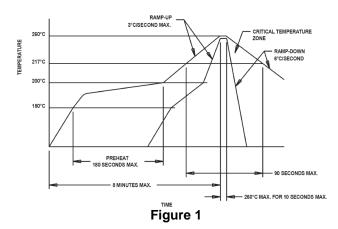




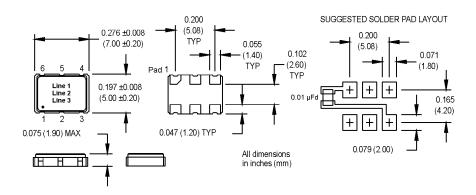


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Soldering Conditions:



Mechanical, Marking, and Pin Out Information:



Datasheet Revision Table:

I	Date	Rev.	Author	Details of Revision
09/	/24/20	0	MM	Original release.